

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MIIKKA FARIN	11/15/2016
RECEIVING PARTY DATA	
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City:	TAMPERE
State/Country:	FINLAND
Postal Code:	33210
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29584594
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ATTORNEY DOCKET NUMBER:	3541-2-001
NAME OF SUBMITTER:	DAVID A. JACKSON
SIGNATURE:	/David A. Jackson/
DATE SIGNED:	11/16/2016
Total Attachments: 2	
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ASSIGNMENT

WHEREAS, I, **Miikka FARIN**, a citizen of Finland,
residing at Kuoppatie 4 B B 7, 00730 Helsinki, FINLAND;

ASSIGNOR, have invented certain new, original and ornamental improvements in a design for

LOCATING AND TRACKING DEVICE

for which I have executed an application for Design Letters Patent of the United States on even date herewith; and

WHEREAS, **YEPZON OY**
with an office at
Finlaysoninkuja 9
33210 Tampere
Finland

ASSIGNEE, is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application;

NOW, THEREFORE, for other good and valuable consideration, the receipt of which is hereby acknowledged, I the said

Miikka FARIN,

have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, to the said

YEPZON OY,

its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said improvements, and the said application and all divisions, renewals, and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, including the right to claim priority under the terms of any appropriate International Convention based upon said application for Letters Patent of the United States, and all Letters Patent which may be granted from said improvements in any country or countries foreign to the United States and extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States, whose duty is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said

YEPZON OY,

its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the interest herein assigned in the manner hereinabove set forth, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the said

YEPZON OY,

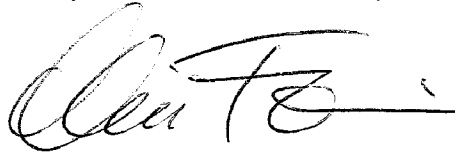
its successors, legal representatives and assigns, any fact known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisions, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said

YEPZON OY,

its successors, legal representatives and assigns, to obtain and enforce proper Patent Protection for said improvements in the United States.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal the day and year set opposite my signature.

Date 15.11.2016



L.S.

Miikka FARIN